

**INVENTORSHIP DECLARATION BY JOINT INVENTORS**

**COPY**

I HEREBY DECLARE THAT:

My residence, mailing address, and citizenship are stated next to my name in PART A hereof. I believe I am the original, first, and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled

**MICROELECTRONIC DEVICES WITH IMPROVED HEAT DISSIPATION AND METHODS  
FOR COOLING MICROELECTRONIC DEVICES**

the specification of which:

- ☒ is attached hereto.
- ☐ was filed on \_\_\_\_\_ as Application Serial No. \_\_\_\_\_ and was amended on \_\_\_\_\_ (if applicable).

I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with 37 CFR §1.56, including, for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application. I hereby claim priority benefits under 35 USC §119(a)-(d) or (f), §172, or §365(a)-(b) of any foreign or international application(s) for patent or inventor's certificate listed in PART B hereof and have also identified in PART B hereof any such foreign or international application having a filing date before that of the application of which priority is claimed.

I hereby declare that all statements made herein of my knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. I understand that the execution of this document does not in itself establish an attorney-client relationship between the undersigned and Perkins Coie, LLP, or any of its attorneys.

See page 2 attached, signed, and made a part hereof.

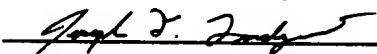
**INVENTORSHIP DECLARATION BY JOINT INVENTORS**

**PART A: INVENTOR INFORMATION AND SIGNATURE**

Full name of FIRST inventor: JOSEPH T. LINDGREN

Citizenship: USA Mailing Address: PO BOX 170042  
BOISE, IDAHO 83717


Residence (if different): BOISE, IDAHO

Inventor's Signature:  Date: 8-23-02

Full name of SECOND inventor: WARREN M. FARNWORTH

Citizenship: USA Mailing Address: 2004 S. BANNER  
NAMPA, IDAHO 83686


Residence (if different): \_\_\_\_\_

Inventor's Signature:  Date: 22-Aug-2002

Full name of THIRD inventor: WILLIAM M. HIATT

Citizenship: USA Mailing Address: 1137 WEST STAFFORD DRIVE  
EAGLE, IDAHO 83616

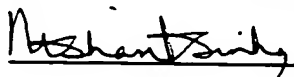
Residence (if different): \_\_\_\_\_

Inventor's Signature:  Date: 08-22-02

Full name of FOURTH inventor: NISHANT SINHA

Citizenship: INDIA Mailing Address: 185 E. MALLARD DR., #238 <sup>N. Sinha</sup> 4008 Federal Way  
BOISE, IDAHO 83706 D-101, Boise, ID-83716

Residence (if different): 4008 Federal Way D-101, Boise, ID-83716

Inventor's Signature:  Date: 8/22/02

**INVENTORSHIP DECLARATION BY JOINT INVENTORS**

**PART B: CLAIM TO PRIORITY OF FOREIGN APPLICATION(S) UNDER 35 U.S.C. 119(a)-(d) and (f) §172, or §365(a)-(b)**

Country	Application No.	Filing Date	Priority Not Claimed
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